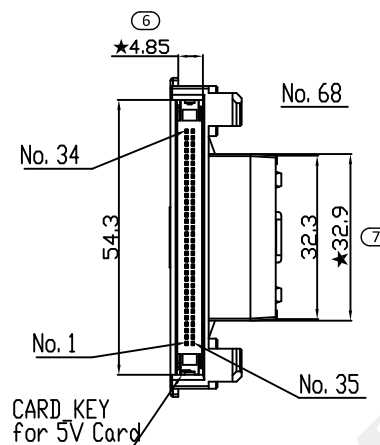
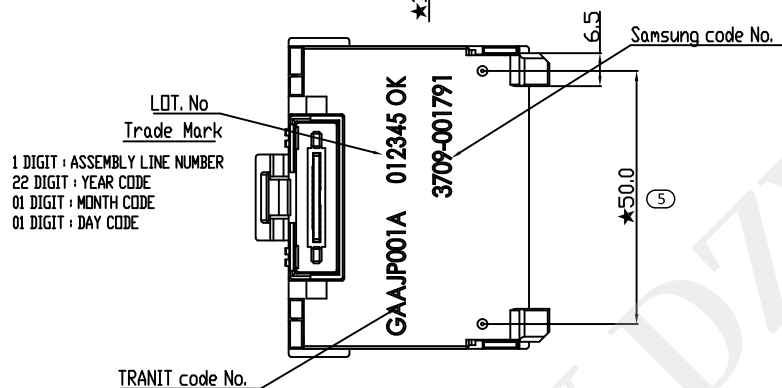
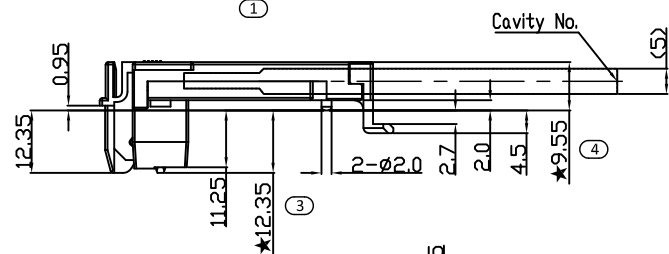
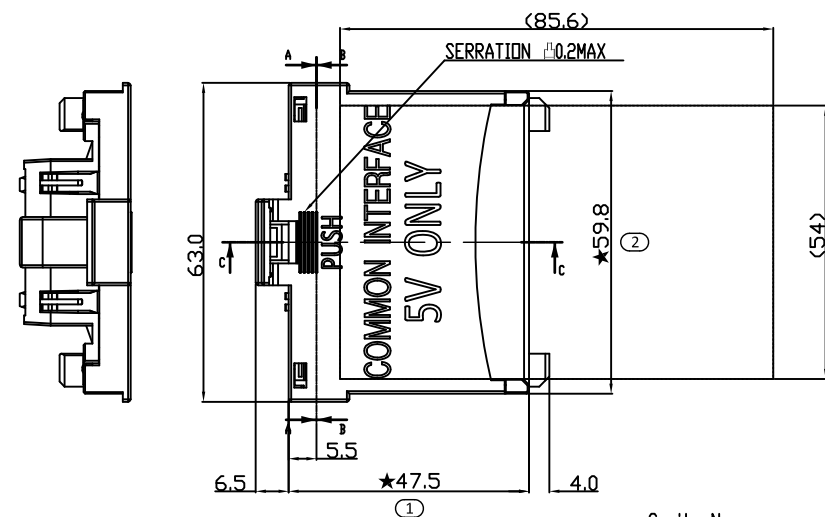
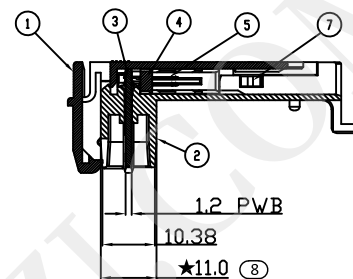


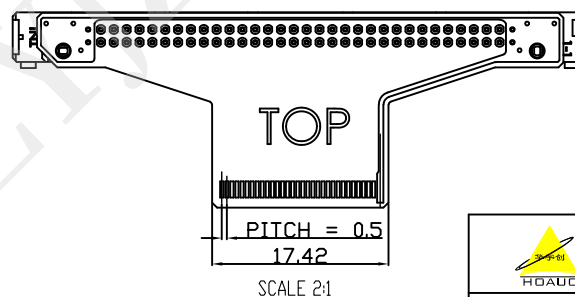
SECTION A-A



SECTION B-B



SECTION C-C



7	Latch Spring	Stainless	清洗	T=0.25
6	GND Spring	Stainless	清洗	T=0.2
5	Terminal	Copper Alloy	Au over Ni	T=0.45
4	Housing	LCP	Black	UL94-V0
3	P.W.B	FR-4	-	T=1.2
2	Lower Case	ABS or PC	Black	UL94-V0
1	Upper Case	ABS or PC	Black	UL94-V0
No.	Part Name	Material	Finish	Remarks

注:

- 端子电镀: 镍底40μ"Min, 端子接触区1.2mm刷镀金2μ"Min. 其它区域刷镀金AU FLASH. 焊脚镀雾锡100U"Min.
- 弹片清洗.



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X' ±2" X.X' ±0.5"	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: COMMON INTERFACE 68P
UNIT: mm [inch] SCALE:1:1 SIZE: A4	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYC02-CI68-630
	APPROVED BY: 邱敏	DATE : 2014-02-23	MOLD NO.
			DRAW NO: HYC-2609231449
			SHEET NO. 1 OF 1